# Advance Information

# **Surface Mount Schottky Power Rectifier**

# **SMB Power Surface Mount Package**

... employing the Schottky Barrier principle in a metal-to-silicon power rectifier. Features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency switching power supplies; free wheeling diodes and polarity protection diodes.

- · Compact Package with J-Bend Leads Ideal for Automated Handling
- Highly Stable Oxide Passivated Junction
- · Guardring for Over-Voltage Protection
- Low Forward Voltage Drop

## **Mechanical Characteristics:**

- · Case: Molded Epoxy
- Epoxy Meets UL94, VO at 1/8"
- Weight: 95 mg (approximately)
- Maximum Temperature of 260°C / 10 Seconds for Soldering
- · Polarity: Notch in Plastic Body Indicates Cathode Lead
- Available in 12 mm Tape, 2500 Units per 13 inch Reel, Add "T3" Suffix to Part Number
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Marking: BKJL

## **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	VRRM VRWM VR	40	V
Average Rectified Forward Current (At Rated V <sub>R</sub> , T <sub>C</sub> = 103°C)	Io	2.0	А
Peak Repetitive Forward Current (At Rated V <sub>R</sub> , Square Wave, 20 kHz, T <sub>C</sub> = 104°C)	IFRM	4.0	А
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	IFSM	70	А
Storage / Operating Case Temperature	T <sub>stg</sub> , T <sub>C</sub>	-55 to 150	°C
Operating Junction Temperature	TJ	-55 to 125	°C
Voltage Rate of Change (Rated V <sub>R</sub> , T <sub>J</sub> = 25°C)	dv/dt	10,000	V/μs

#### THERMAL CHARACTERISTICS

Thermal Resistance – Junction–to–Lead (2)	R <sub>til</sub>	22.5	°C/W	1
Thermal Resistance – Junction–to–Ambient (3)	R <sub>tja</sub>	78		

## **ELECTRICAL CHARACTERISTICS**

Maximum Instantaneous Forward Voltage (1), See Figure 2	VF	T <sub>J</sub> = 25°C	T <sub>J</sub> = 125°C	V
$(I_F = 2 A)$ $(I_F = 4 A)$		0.43 0.50	0.34 0.45	
Maximum Instantaneous Reverse Current, See Figure 4	I <sub>R</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 100°C	mA
$(V_R = 40 \text{ V})$ $(V_R = 20 \text{ V})$		0.80 0.10	20 6.0	

- (1) Pulse Test: Pulse Width ≤ 250 μs, Duty Cycle ≤ 2.0%.
- (2) Minimum pad size (0.108 X 0.085 inch) for each lead on FR4 board.
- (3) 1 inch square pad size (1 X 0.5 inch for each lead) on FR4 board.

This document contains information on a new product. Specifications and information herein are subject to change without notice.

## **MBRS2040LT3**

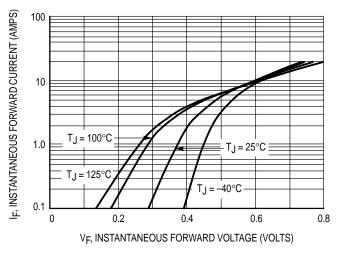
SCHOTTKY BARRIER RECTIFIER 2.0 AMPERES 40 VOLTS



CASE 403A-03 SMB



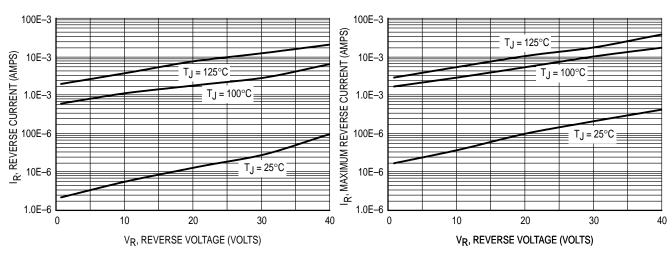
## **MBRS2040LT3**



100 T<sub>J</sub> = 100°C T<sub>J</sub> = 25°C T<sub>J</sub> = 25°C T<sub>J</sub> = 25°C T<sub>J</sub> = 25°C V<sub>F</sub>, MAXIMUM INSTANTANEOUS FORWARD VOLTAGE (VOLTS)

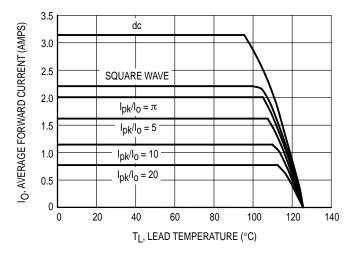
Figure 1. Typical Forward Voltage

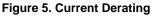
Figure 2. Maximum Forward Voltage



**Figure 3. Typical Reverse Current** 

**Figure 4. Maximum Reverse Current** 





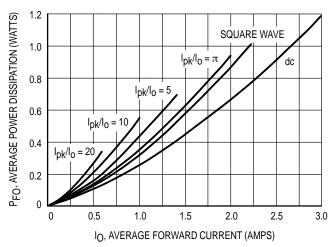


Figure 6. Forward Power Dissipation

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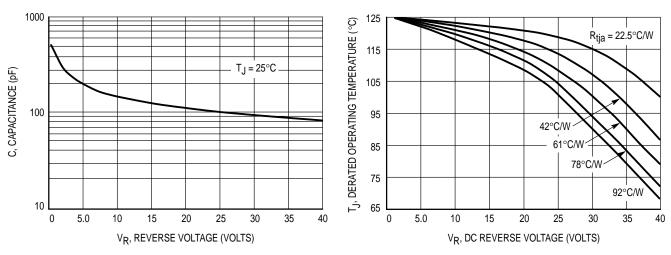


Figure 7. Capacitance

Figure 8. Typical Operating Temperature Derating\*

\* Reverse power dissipation and the possibility of thermal runaway must be considered when operating this device under any reverse voltage conditions. Calculations of T<sub>J</sub> therefore must include forward and reverse power effects. The allowable operating T<sub>J</sub> may be calculated from the equation:

 $T_J = T_{Jmax} - r(t)(Pf + Pr)$  where

r(t) = thermal impedance under given conditions,

Pf = forward power dissipation, and

Pr = reverse power dissipation

This graph displays the derated allowable  $T_J$  due to reverse bias under DC conditions only and is calculated as  $T_J = T_{Jmax} - r(t)Pr$ , where r(t) = Rthja. For other power applications further calculations must be performed.

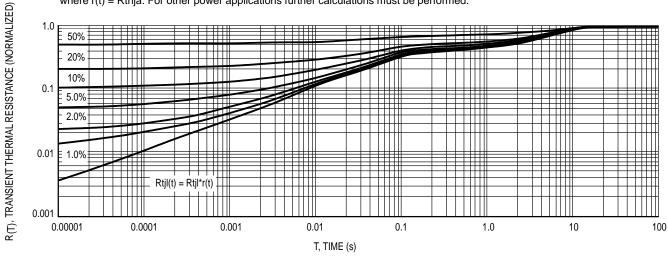


Figure 9. Thermal Response Junction to Lead

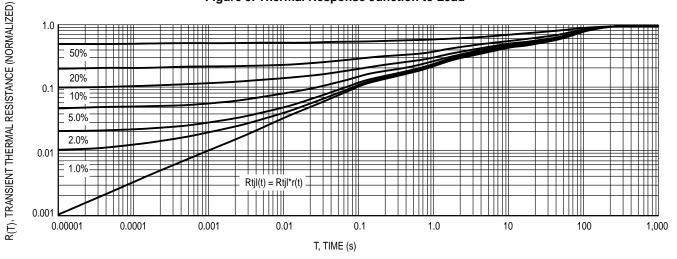
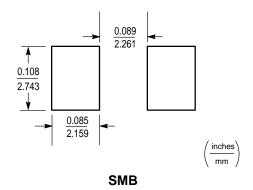
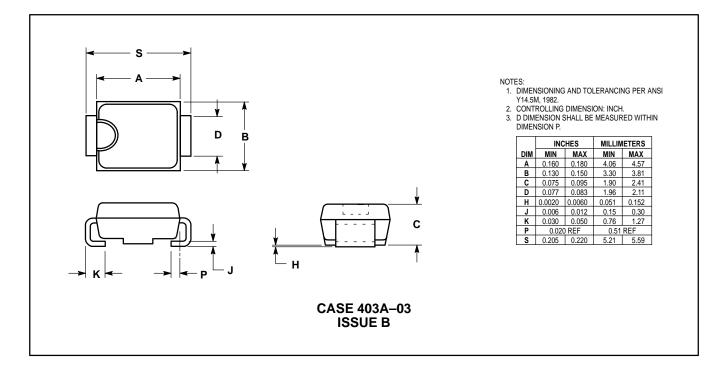


Figure 10. Thermal Response Junction to Ambient

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#### PACKAGE DIMENSIONS



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